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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

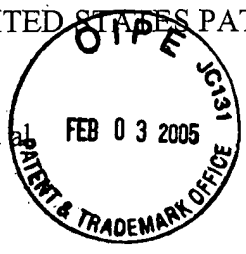
In re Application of:

Chad A. Cobbley et al

Serial No.: 10/672,750

Filed: September 25, 2003

For: STACKED DIE MODULE AND
TECHNIQUES FOR FORMING A
STACKED DIE MODULE



Group Art Unit: 2811

Examiner: Blum, David S.

Atty Docket: MICS:0078—1/FLE/MAN
(01-0752.01)

Mail Stop Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313

CERTIFICATE OF TRANSMISSION OR MAILING 37 C.F.R. 1.8	
I hereby certify that this correspondence is being transmitted by facsimile to the United States Patent and Trademark Office in accordance with 37 C.F.R. 1.6(d) or is being deposited with the U.S. Postal Service as First Class Mail in an envelope addressed to: Mail Stop Amendment, Commissioner for Patents, Alexandria, VA 22313, on the date below:	
January 28, 2005 Date	 Kerri Hyland

RESPONSE TO OFFICE ACTION DATED DECEMBER 1, 2004

Sir:

In response to the Office Action dated December 1, 2004, please amend the above-identified application as follows: